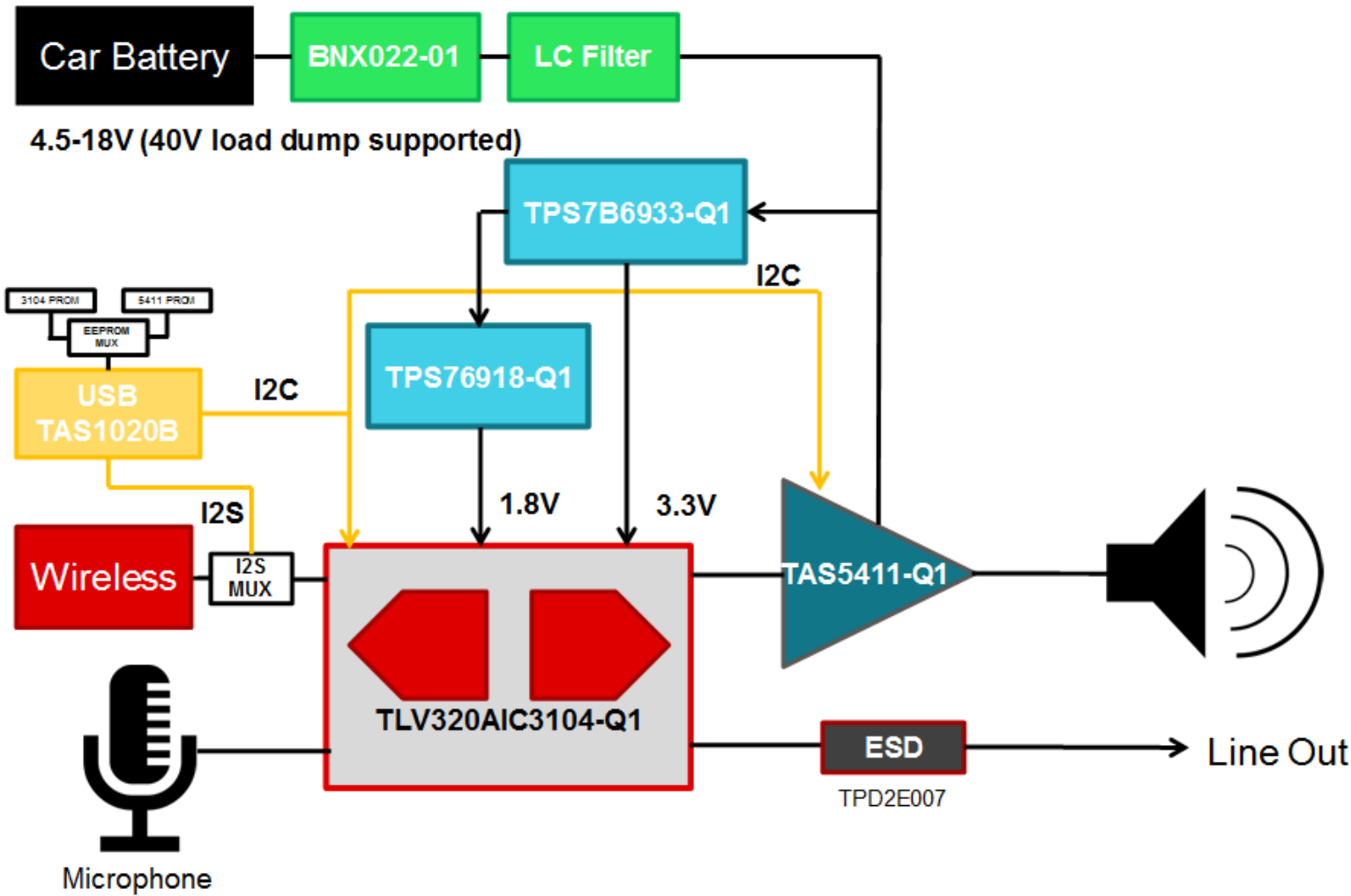
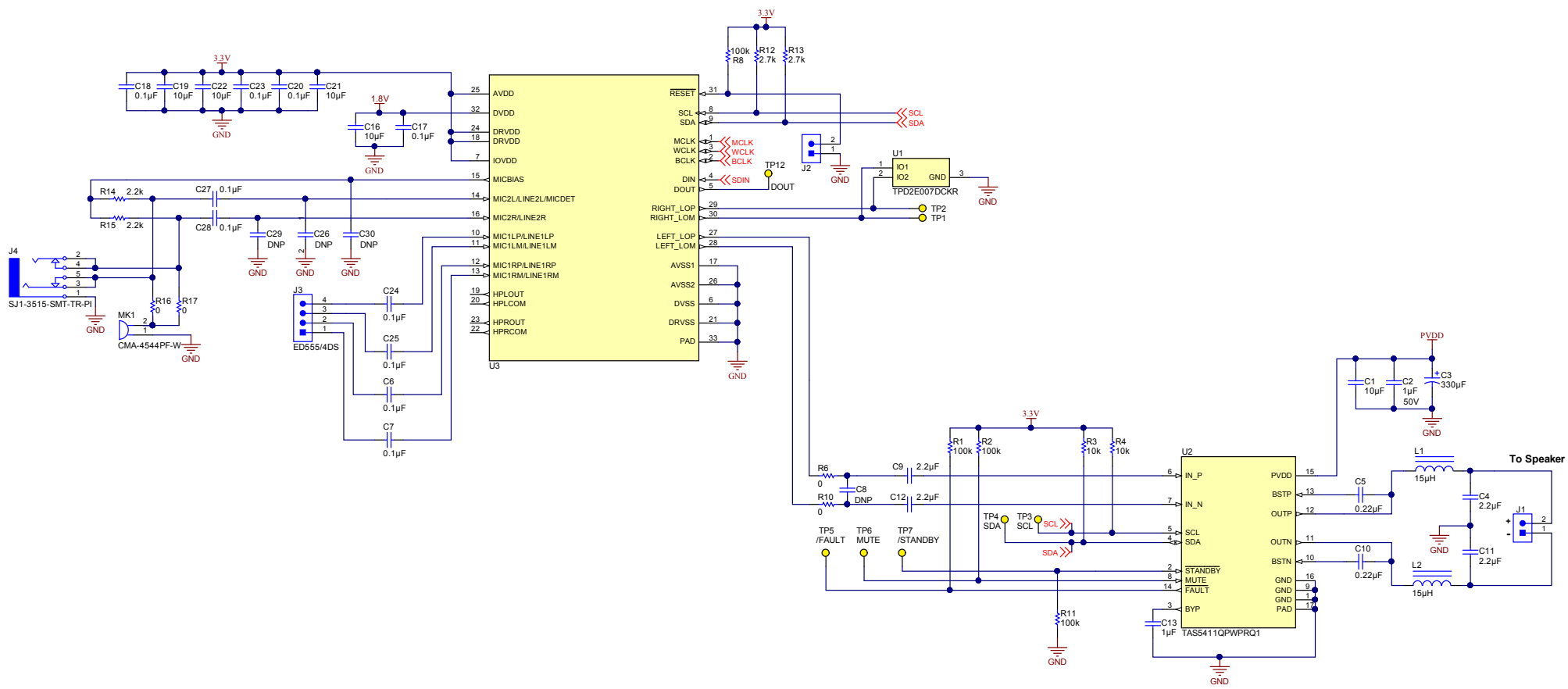


Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

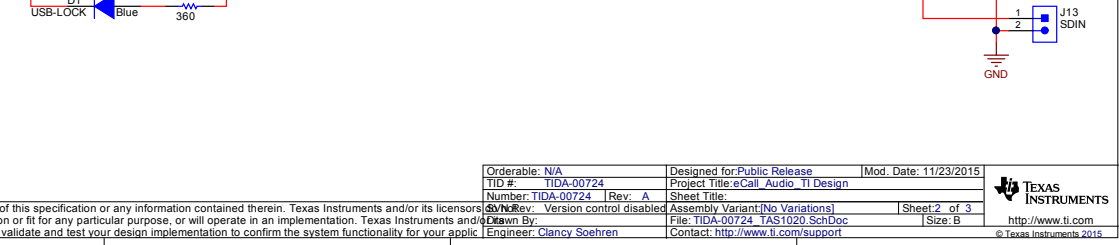
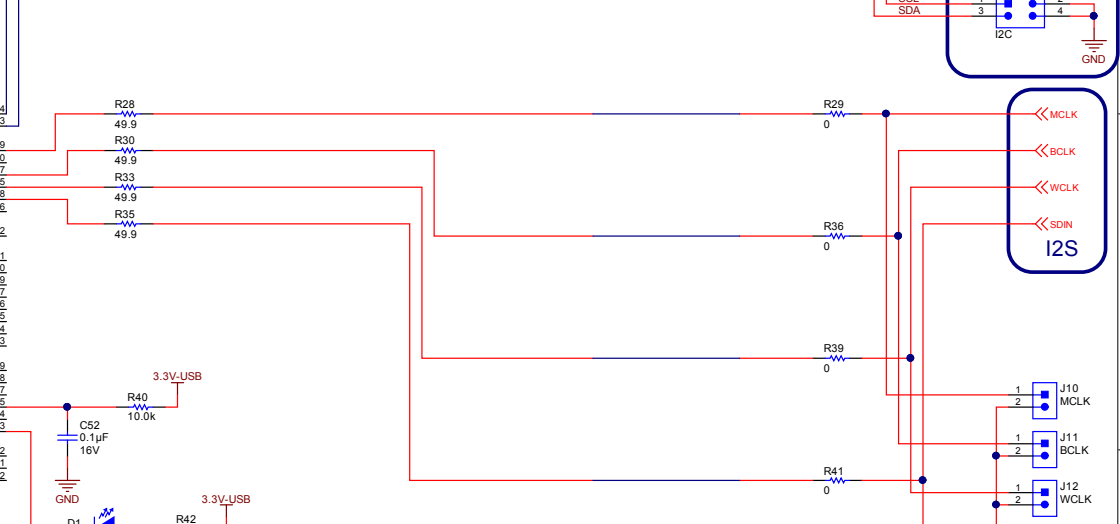
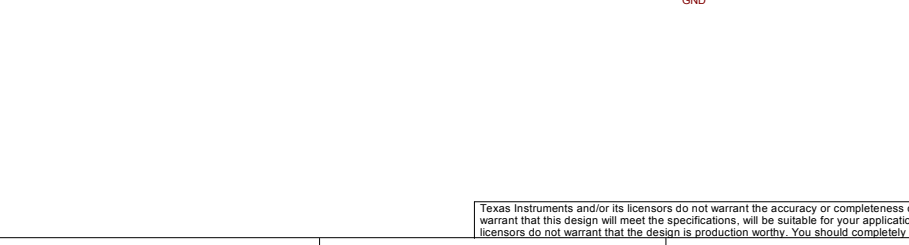
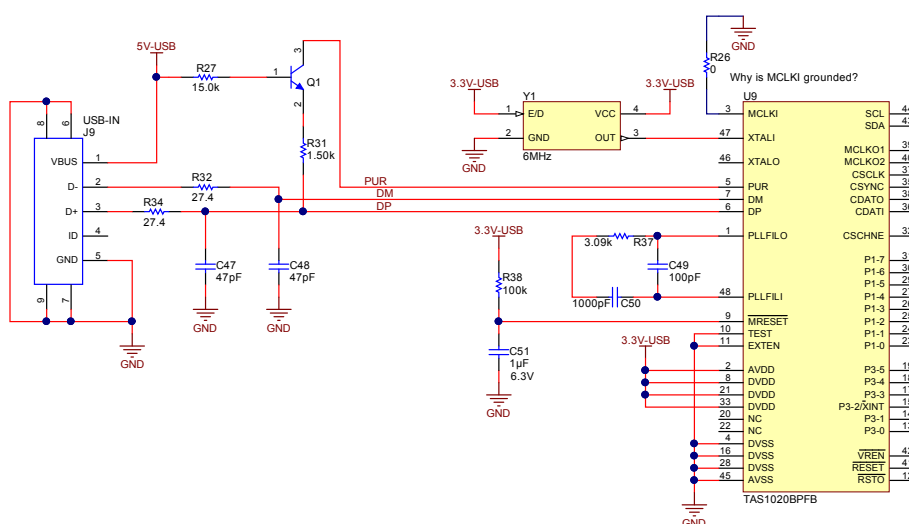
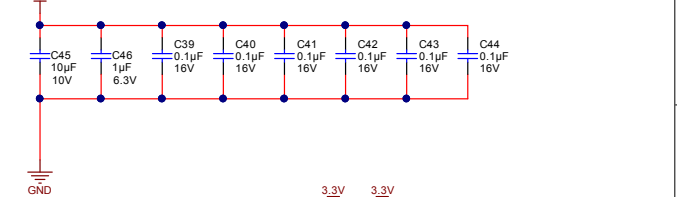
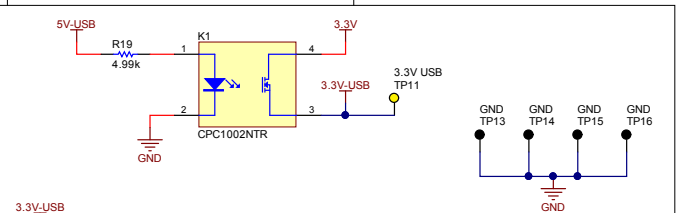
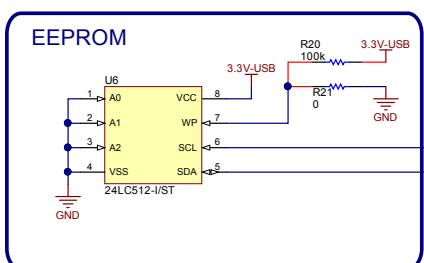




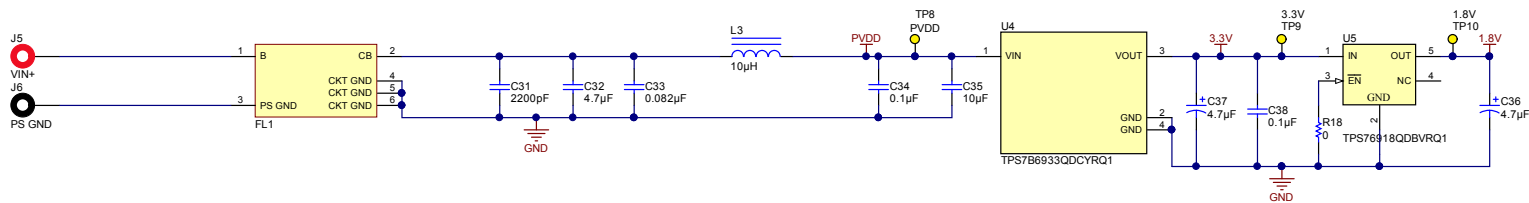
Choose new microphone and figure out how to bias

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Orderable: N/A	Designed for: Public Release	Mod. Date: 11/23/2015
TID #: TIDA-00724	Project Title: eCall Audio TI Design	
Number: TIDA-00724 Rev: A	Sheet Title:	
Drawn By: [Name]	Assembly Variant: [No Variations]	Sheet: 2 of 3
Engineer: Clancy Soehren	File: TIDA-00724_Audio_SchDoc	Size: B
	Contact: http://www.ti.com/support	



1 2 3 4 5 6



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H1
NY PMS 440 0025 PH

H2
NY PMS 440 0025 PH

H3
NY PMS 440 0025 PH

H4
NY PMS 440 0025 PH

H5
1902C

H6
1902C

H7
1902C

H8
1902C

FID1

FID2

FID3

PCB Number: TIDA-00724
PCB Rev: A

PCB
LOGO
Texas Instruments

PCB
LOGO
Pb-Free Symbol

Label Table	
Variant	Label Text
001	TIDA-00724

ZZ1

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A

TID #: TIDA-00724

Number: TIDA-00724 | Rev: A

Drawn By: Engineer: Clancy Soehren

Designed for: Public Release

Project Title: eCall Audio TI Design

Sheet Title: Assembly Variant[No Variations]

File: TIDA-00724_Hardware.SchDoc

Contact: http://www.ti.com/support

Mod. Date: 11/23/2015

Sheet: 3 of 3

Size: B

TEXAS
INSTRUMENTS

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